

Jameco Part Number 668529

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1.0 SCOPE

This specification covers the 1.27mm (.050 inch) centerline DIMM socket board to board interconnect for 1.27+/-0.10 (.050+/-.004 in.) thick memory modules.

2.0 PRODUCT DESCRIPTION

2.1 PRODUCT NAME AND PART NUMBER

Product Name

Dual In-Line Memory Module (DIMM)

Series Numbers

71243, 71251, 71481, 71729, 71736, 73705, 73817, 73818, 73822, 74080, 74081, 70482 Series.

2.2 DIMENSIONS, MATERIALS, PLATINGS AND MARKINGS

See the appropriate Sales Drawings for information on dimensions, materialsplatings and markings, recommended module outlines and footprint patterns.

2.3 UL/CSA CERTIFICATION

UL file: E29179 CSA file: LR-19980A-366

3.0 APPLICABLE DOCUMENTS AND SPECIFICATIONS

See the Sales Drawings and the other sections of this Specification for the necessary referenced Documents and Specifications.

4.0 RATINGS

- 4.1 VOLTAGE 100 Volts AC (RMS)/DC
- 4.2 CURRENT 1.0 Amps
- **4.3 TEMPERATURE** Operating: - **40** °C to + **85** °C Nonoperating: - **55** °C to + **85** °C

		REVISE ON PC ONLY	TITLE 1.25 (050 IN) DIFCH DUAL IN LINE					
	С	SEE SHEET 1	1.27 mm (.050 IN.) PITCH DUAL IN-LINE MEMORY MODULE CONNECTOR					
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5.0 PERFORMANCE

5.1 ELECTRICAL PERFORMANCE

Item	Test Condition	Requirement
Contact Resistance (Low Level)	Mate Connectors with a maximum voltage of 20mV and a current of 100 mA. (Measurement Locations in Section 8.3)	30 milliohm Maximum Initial
Insulation Resistance	Mate Connectors with a voltage of 500 VDC between adjacent terminals and between terminals and ground.	1000 Megohms Minimum
Dielectric Withstanding Voltage	Mate Connectors with a voltage of 500 VAC for 1 minimum between adjacent terminals and between terminals and ground.	No breakdown
Capacitance	Measure between adjacent terminals at 1 MHz. (Loaded: 50 ohms impedence)	Loaded: 2 picofarad maximum. Unloaded: 0.5 picofarad maximum.

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5.1 ELECTRICAL PERFORMANCE CONTINUED

5.1.1 Characteristics: Loaded condition (Module inserted

	1:1 S:G	Configuration	3:1 S:G	Configuration
PARAMETER	Average	Range	Average	Range
Capacitance(pF)	1.06	nominal	1.05	1.01-1.06
Inductance(nH)	3.18	nominal	3.65	3.453.94
Propagation Delay (psec)	57.5	nominal	59.3	58.3-60.6
Risetime Degradation (psec)	16.41	NA	28.96	NA
Bandwidth (GHz)	21.3	NA	12.1	NA
Impedance (ohms) @ 45 psec	54.4	nominal	58.3	nominal
% Crosstalk (1v/1ns)	N.E.	F.E.	N.E.	F.E.
1 Drive	0.33%	-0.28%	1.26%	-0.75%
4 Drives	0.90%	-0.82%	3.33%	-2.35%
7 Drives	1.10%	-0.92%	4.57%	-3.50%

5.1.2 Characteristics: Unloaded condition

	1:1 S:G	Configuration	3:1 S:G	Configuration
PARAMETER	Average	Range	Average	Range
Capacitance (pF)	0.36	nominal	0.34	0.29-0.36

Note: All data is based on analytical analysis. Contact Molex Inc. Corporate Headquarters for Spice model and additional information..

		REVISE ON PC ONLY	TITLE 1.27 mm (.050 IN.) PITCH DUAL IN-LINE MEMORY MODULE CONNECTOR THIS DOCUMENT CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX					
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5.2 MECHANICAL PERFORMANCE

Item	Test Condition	Requirement
Total Insertion and Withdrawal Force (excl. latches)	Insert and withdraw a steel blade at a rate of 25 +/- 6mm (1+/- 1/4 inch) per minute. Latches shall be excluded in the test. (Gage dimensions in Section 8.1)	Insertion force shall be 0.78 N (2.8 oz) maximum with maximum blade, and withdrawal 0.07 N (0.25 oz) min imum. with minimum. blade per contact respectively x the total contact population
Total Insertion Force (w/ latches)	Insert a nominal thick PCB w/o chamfer at a rate of 25 +/- 6mm (1+/- 1/4 inch) per minute. Latches shall be included in the test.	Maximum Insertion force shall be 0.83 N (3.3 oz) max. per contact respectively x the total contact population
Terminal Retention Force in Housing	Axial pullout force on the terminal in the housing at a rate of 25 +/- 6mm (1 +/- 1/4 inch) per minute.	Contact : 4.45 N (1.0 lbs.) minimum Forklock : 22.24 N. (5.0 lbs) minimum.
Durability	Mate connectors up to 25 cycles at a maxiumum rate of 10 cycles per minute prior to defined Environmental Tests.	Contact Resistance : 10 milliohms Maximum Change from Initial
Vibration Mil-Std-1344 Method 2005.1 Condition I	Amplitude: 1.50mm (.060 inch) peak to peak Sweep: 10-55-10 Hz in one minute Duration: 2 hours in each X-Y-Z axis. (Test module shall be per Section 8.2)	Contact Resistance: 10 milliohms Maximum Change from Initial Discontinuity: not greater than one microsecond
Mechanical Shock Mil-Std-1344 Method 2004.1 Condition A	50 g's with three 1/2 sine waveform shocks in each X-Y-Z axis. (Test module shall be per Section 8.2)	Contact Resistance: 10 milliohms Maximum Change from Initial Discontinuity: not greater than one microsecond
Latch Overstress Force	Apply an actuation force on the latch at a rate of $25 \pm - 6$ mm (1 $\pm - 1/4$ inch) per minute in the fully open position and hold for 10 sec.	66.72 N (15 lbs) minimum. force held for 10 sec., no damage.
Latch Actuation Force	Apply an actuation force on the latch at a rate of $25 + -6 \text{mm} (1 + -1/4 \text{ inch})$ per minute with recommended test module inserted into connector.	The force to fully actuate the latch open shall be 44.48 N (10 lbs) maximum per latch.
Normal Force	Apply a perpendicular force at a rate of 25+/- 6mm (1 +/- 1/4 inch) per minute on the contacts in a manner simulating actual use.	0.49 N (50 grams) minimum end of life.

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5.2 MECHANICAL PERFORMANCE CONTINUED

	Item	Te	st Condition	Requ	iirement	
Module	Ripout Force	Pull up from the the latches closed +/- 1/4 j	e center of the module with d at a rate of 25 +/- 6mm (1 inch) per minute.	TALL LATCH	SHORT LATCH	
				The module ripo (20 lbs) minimus connector that has latch at both end above.	out forces is 88.96 N m for a DIMM as a tall or short ls. See figures	
				The module ripo (8 lbs) minimum connector that ha both ends, and th that have only on and a tower at th	but forces is 35.58 N n for a DIMM as a DRO latch at ne tower options ne tall or short latch ne other end. See	
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5.2 MECHANICAL PERFORMANCE CONTINUED

Item	Test Condition	Requirement
Normal Force	Apply a perpendicular force at a rate of $25+/-6$ mm (1+/- $\frac{1}{4}$ inch per minute on the contacts in a manner simulating actual use.	0.49 N (50 grams) minimum end of life.
Retention of connector to PCB	Pull connector out of max. recommended diameter holes. PCB: 1.57+/-0.18 mm (.062+/007 inch) thick. Rate: 25.4+/-6 mm (1.0+/-1/4 inch) per minute.	The connector shall not lift off the PCB when pulling up either end with a force of 4.45 N (1.0 lbs) minimum. 22.24 N (5 lbs) max.
Insertion force of connector into PCB	Push connector into min. recommended diameter holes. PCB: 1.57+/-0.18 mm (.062+/007 inch) thick. Rate: 25.4+/-6mm (1.0+/-1/4inch) per minute.	Plastic peg: 44.48 N (10.0 lbs.) per peg maximum. Metal forklock: 26.69 N (6.0 lbs) per peg maximum.
Durability of marking	Brush connector per Mil-Std-202, Method 215 with isopropyl alchohol solution.	No degradation of the marking

5.3 ENVIROMENTAL PERFORMANCE

Item	Test Condition	Requirement
Thermal Shock Mil-Std-202F Method 107 E	Mate connectors exposed to 5 cycles of: Temperature °C Duration (Min) -40 +0/-3 15 +25 +/-10 5 Max +65 +3/-0 15 +25 +/-10 5 Max	Appearance: No Damage Contact Resistance: 10 milliohms maximum change from initial
Thermal Aging Mil-Std-202F Method 108	Mated connector exposed to 240+/-10 hrs. at 85+/- 3° C	Appearance: No Damage Contact Resistance: 10 milliohms maximum change from initial
Humidity (Steady State) Mil-Std-202F Method 103	Mated connectors exposed to a temperature of : 50 +/- 2°C with a Relative of 80+/-3% for 300 hours. Remove surface moisture and air dry for 24 hours prior to measurements.	Appearance: No Damage Contact Resistance: 10 milliohms maximum change from initial. Dielectric Withstanding Voltage: No Breakdown Insulation Resistance: 1000 Megohms Minimum

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5.3 ENVIROMENTAL PERFORMANCE CONTINUED

Item	Test Condition	Requirement			
Temperature Cycling	Mated connectors exposed for 335 cycles Relative Humidity uncontrolled with a temperature transition of 10° C per minute.Temperature °C +0 +/- 3Duration (Min) 15 +75 +/-3Allow to air dry for 24 hours prior to measurements.	Appearance: No Damage Contact Resistance: 10 milliohms maximum change from initial. Dielectric Withstanding Voltage: No Breakdown Insulation Resistance: 1000 Megohms Minimum			
Temperature Rise	Mate the connectors, series 4 contacts and measure the temperature rise at the rated current after 4 hours. (Schematic per Section 8.3)	Maximum Temperature Rise: 30°C above ambient			
Solderability Molex SMES-152	Steam age 1 hr. Solder time 5 +/- 0.5 seconds. Solder temperature: 245 +/- 5°C Nonactivated flux.	95% of the immersed area must show no voids, pin holes			
IR Process	Exposure: Molex IR Profile per Section 8.4	Appearance: No damage, blister- ing or solder bridging. Dimensional: Conformance to Sales Drawing requirements			
Flowing Mixed Gas (FMG)	Battelle Class II, 10 ppm Cl ₂ 10 ppm H ₂ S, 100 ppm NO ₂ , 70+/-1% R.H., 25 deg. C. 50-60 CFM 10 days mated and 7 days unmated exposure.	Contact Resistance: 10 milliohms Maximum change from Initial			
Resistance to Solder Heats	Solder Time 3 +/- 0.5 seconds Solder Temperature: 260 +/- 5°C Immerse leads to a depth of 1.57mm (.062 in.) from connector body.	Appearance: No damage or discoloration of connector materials.			

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6.1 QUALIFICATION REQUIREMENTS

- 6.1.1 Samples shall be taken from approved production processes.
- 6.1.2 A minimum of 1000 contact points and 5 connectors per group shall be tested typically from the smallest and largest circuit size.
- 6.1.3 Acceptance criteria shall be as defined in the applicable test requirement in sections 5.1 5.3.

7.0 PACKAGING

7.1 METHOD

7.1.1 Product shall be packaged in trays per the packaging specification as called out on the applicable assembly print.

7.2 REQUIREMENTS

7.2.1 Packaging shall meet the requirements and be tested per Molex specification PK-70180-5001.

8.0 GAGES, FIXTURES AND SCHEMATICS

8.1 Contact Insertion and Withdrawal Blades

SIZE	OUTLINE				mm(in.)	(weighted)	(unweighted)	
112	MO-172	21.91(.863)	48.89(1.925)	21.97(.865)	38.10(1.5)	18.00	10.10	
128	MO-167	24.45(.963)	48.90(1.925)	21.97(.865)	25.40(1.0)	14.05	6.73	
136	NA	25.72(1.013)	51.44(2.025)	21.97(.865)	25.40(1.0)	15.74	7.08	
144	NA	26.99(1.063)	53.98(2.125)	21.97(.865)	25.40(1.0)	17.62	7.43	
160	NA	29.53(2.325)	59.06(2.325)	21.97(.865)	25.40(1.0)	22.11	8.13	
168	168MO-16130.80(1.213)61.60(2.425)200MO-17235.88(1.413)76.83(3.025)		61.60(2.425)	21.97(.865)	38.10(1.5)	24.76	13.77	
200			21.97(.865)	38.10(1.5)	38.96	15.87		

8.2 Shock and Vibration Test Modules

Notes

- 1. Item 1 (weights) shall be poxied to recommended module test board. Material shall be aluminum.
- 2. Total weight of finished test module shall be per the table.

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	PART NUMBER	COLO			OLTAGE KEY	DIA. "A"	DIA. "B"		DIA. "C"	DIA. "D"	DIM. "H	DIM. "P"	DIM. "S"	DIM. "T"	DIM. W	DIM. "X"	DIM. "Y"	DIM. "Z"	CONTACT AREA PLATING	Ĩ
J	7 125 1-000 1	BLAC	K 3.3 VOLT	SEE SHE	ET 2														OPTION A	J
	71251-0002	BLAC	K 3.3 VOLT STD DRAM	CENTER (ENTER	NONE	.093 +.003/- (2.36+0.08/-	.000 0.00)	.093 +.003/000 (2.36+0.08/-0.00)	NONE	1.700 (43.18)	<u>. 155</u> (3.94)	.020 (0.51)	<u>.127</u> (3.23)	.970 (24.64)	<u>.113</u> (2.87)	<u>.250</u> (6.35)	<u>.4 0</u> (0.4)	OPTION A	
	71251-0003	BLAC	K 5.0 VOLT STD DRAM	CENTER)FFSET LEFT	NONE	.093 +.003/- (2.36+0.08/-	.000 0.00)	.093 +.003/000 (2.36+0.08/-0.00)	NONE	1.700 (43.18)	.155 (3.94)	.020 (0.51)	.127 (3.23)	.970 (24.64)	.113 (2.87)	.250 (6.35)	.410 (10.41)	OPTION A	
I	7 25 -0004	BLAC	K 5.0 VOLT STD DRAM	SEE SHE	ET 2														OPTION A	I
	71251-0005	BLAC	K 5.0 VOLT UNBUFFERED	OFFSET (RIGHT)FFSET LEFT	.080±.002 (2.03±0.05)	NONE		NONE	.080±.002 (2.03±0.05)	1.661 (42.19)	.125 (3.18)	.035 (0.89)	.102 (2.59)	.985 (25.02)	.128 (3.25)	<u>.265</u> (6.73)	.425 (10.79)	OPTION A	
	7 125 1-0006	BLAC	K 5.0 VOLT STD DRAM	CENTER)FFSET LEFT	.080±.002 (2.03±0.05)	NONE		.093 +.003/000 (2.36+0.08/-0.00)	.080±.002 (2.03±0.05)	1.700 (43.18)	.155 (3.94)	.020 (0.51)	<u>.127</u> (3.23)	.970 (24.64)	.113 (2.87)	.250 (6.35)	<u>.4 0</u> (0.4)	OPTION A	
н	71251-0007	BLAC	K 3.3 VOLT STD DRAM	CENTER C	ENTER	.080±.002 (2.03±0.05)	NONE		.080±.002 (2.03±0.05)	.080±.002 (2.03±0.05)	1.700 (43.18)	.140 (3.56)	.020 (0.51)	<u>.127</u> (3.23)	.970 (24.64)	.11 <u>3</u> (2.87)	.250 (6.35)	<u>.4 0</u> (0.4)	OPTION A	н
	71251-0008	BLAC	K 5.0 VOLT STD DRAM	CENTER)FFSET LEFT	NONE	.093 +.003/- (2.36+0.08/-	.000 0.00)	.093 +.003/000 (2.36+0.08/-0.00)	.093 +.003/000 (2.36+0.08/-0.00)	<u> .700</u> (43.18)	<u>.155</u> (3.94)	.020 (0.51)	<u>.127</u> (3.23)	.970 (24.64)	<u>.113</u> (2.87)	<u>.250</u> (6.35)	<u>.4 0</u> (0.4)	OPTION A	1
	71251-0009	BLAC	K 5.0 VOLT STD DRAM	CENTER)FFSET LEFT	.080±.002 (2.03±0.05)	NONE		NONE	.080±.002 (2.03±0.05)	1.700 (43.18)	.125 (3.18)	.035 (0.89)	.102 (2.59)	.985 (25.02)	.128 (3.25)	<u>.265</u> (6.73)	.425 (10.79)	OPTION A	
G	7 125 1-00 10	BEIG	3.3 VOLT STD DRAM	CENTER (ENTER	.080±.002 (2.03±0.05)	NONE		NONE	.080±.002 (2.03±0.05)	1.700 (43.18)	<u>.125</u> (3.18)	.035 (0.89)	<u>.112</u> (2.84)	.985 (25.02)	.128 (3.25)	<u>.265</u> (6.73)	.425 (10.79)	OPTION A	G
	71251-0011	BLAC	K 3.3 VOLT STD DRAM	CENTER C	ENTER	.093 +.003/000 (2.36+0.08/-0.00)	NONE		<u>.093</u> +.003/000 (2.36+0.08/-0.00)	<u>.093</u> +.003/000 (2.36+0.08/-0.00)	<u> .700</u> (43.18)	<u>.155</u> (3.94)	<u>.020</u> (0.51)	<u>.127</u> (3.23)	.970 (24.64)	<u>.113</u> (2.87)	<u>.250</u> (6.35)	<u>.4 0</u> (0.4)	OPTION A	-
	7 125 1-00 12	BLAC	K 3.3 VOLT	SEE SHE	ET 2														OPTION A	1
	7 125 1-00 13	BLAC	K 5.0 VOLT	SEE SHE	ET 2														OPTION A	1_
г	7 25 -00 4	BLAC	K 3.3 VOLT UNBUFFERED	OFFSET (RIGHT	ENTER	.080±.002 (2.03±0.05)	NONE		NONE	.080±.002 (2.03±0.05)	1.661 (42.19)	<u>.125</u> (3.18)	<u>.035</u> (0.89)	<u>.112</u> (2.84)	.985 (25.02)	.128 (3.25)	<u>.265</u> (6.73)	<u>.425</u> (10.79)	OPTION A	1
	7 125 1-00 15	BLAC	K 3.3 VOLT STD DRAM	CENTER (ENTER	.080±.002 (2.03±0.05)	NONE		.093 +.003/000 (2.36+0.08/-0.00)	.093 +.003/000 (2.36+0.08/-0.00)	1.700 (43.18)	.155 (3.94)	.020 (0.51)	<u>.117</u> (2.97)	.970 (24.64)	<u>.113</u> (2.87)	<u>.250</u> (6.35)	<u>.4 0</u> (0.4)	OPTION A	F , 71251 ,
	7 25 -00 6	BLAC	K 3.3 VOLT SYNCHRONOU	SEE SHE	ET 2														OPTION A	h
E	7 25 -00 7	BLAC	K 5.0 VOLT SYNCHRONOU	s see she	ET 2														OPTION A	712
	7 125 1-00 18	BLAC	K 3.3 VOLT UNBUFFERED	OFFSET RIGHT	ENTER	.093 +.003/000 (2.36+0.08/-0.00)	NONE		.093 +.003/000 (2.36+0.08/-0.00)	.093 +.003/000 (2.36+0.08/-0.00)	1.661 (42.19)	.140 (3.56)	.035 (0.89)	.102 (2.59)	.985 (25.02)	.128 (3.25)	<u>.265</u> (6.73)	.425 (10.79)	OPTION A	5
	7 125 1-00 19	BLAC	K 5.0 VOLT STD DRAM	CENTER)FFSET LEFT	NONE	.093 +.003/- (2.36+0.08/-	.000 0.00)	.093 +.003/000 (2.36+0.08/-0.00)	NONE	1.700 (43.18)	.155 (3.94)	.020 (0.51)	<u>.127</u> (3.23)	.970 (24.64)	<u>.113</u> (2.87)	<u>.250</u> (6.35)	<u>.4 0</u> (0.4)	OPTION B	\mathbb{P}
D	7 125 1-0020	BLAC	K 3.3 VOLT STD DRAM	CENTER C	ENTER	.080±.002 (2.03±0.05)	NONE		.080±.002 (2.03±0.05)	.080±.002 (2.03±0.05)	1.700 (43.18)	<u>.140</u> (3.56)	.020 (0.51)	<u>.127</u> (3.23)	<u>.970</u> (24.64)	<u>.113</u> (2.87)	<u>.250</u> (6.35)	<u>.4 0</u> (0.4)	OPTION B	D
	7 125 1-002 1	BLAC	K 3.3 VOLT STD DRAM	CENTER C	ENTER	.080±.002 (2.03±0.05)	NONE		.093 +.003/000 (2.36+0.08/-0.00)	<u>.093</u> +.003/000 (2.36+0.08/-0.00)	(43.18)	<u>.155</u> (3.94)	.020 (0.51)	<u>.127</u> (3.23)	<u>.970</u> (24.64)	<u>.113</u> (2.87)	<u>.250</u> (6.35)	<u>.4 0</u> (0.4)	OPTION B]
	7 125 1-0022	BLAC	K 3.3 VOLT UNBUFFERED	OFFSET C	ENTER	.080±.002 (2.03±0.05)	NONE		<u>.093</u> +.003/000 (2.36+0.08/-0.00)	<u>.093</u> +.003/000 (2.36+0.08/-0.00)	(42.19)	<u>.155</u> (3.94)	.020 (0.51)	<u>.127</u> (3.23)	<u>.970</u> (24.64)	<u>.113</u> (2.87)	<u>.250</u> (6.35)	<u>.4 0</u> (0.4)	OPTION B	
С	7 25 -0023	BLAC	K 3.3 VOLT UNBUFFERED	OFFSET C	ENTER	.080±.002 (2.03±0.05)	NONE		NONE	.080±.002 (2.03±0.05)	1.66 l (42.19)	.125 (3.18)	.035 (0.89)	102 (2.59)	.985 (25.02)	.128 (3.25)	<u>.265</u> (6.73)	.425 (10.79)	OPTION A	С
	7 25 -0024	BLAC	K 3.3 VOLT UNBUFFERED	OFFSET C	ENTER	.080±.002 (2.03±0.05)	NONE		<u>.093</u> +.003/000 (2.36+0.08/-0.00)	<u>.093</u> +.003/000 (2.36+0.08/-0.00)	(42.19)	<u>.155</u> (3.94)	.020 (0.51)	.105 (2.67)	<u>.970</u> (24.64)	<u>.113</u> (2.87)	<u>.250</u> (6.35)	<u>.4 0</u> (0.4)	OPTION A	
	7 125 1-0026	BEIG	3.3 VOLT STD DRAM	CENTER C	ENTER	.080±.002 (2.03±0.05)	NONE		NONE	.080±.002 (2.03±0.05)	1.700 (43.18)	<u>.125</u> (3.18)	.035 (0.89)	.090 (2.29)	<u>.985</u> (25.02)	.128 (3.25)	<u>.265</u> (6.73)	.425 (10.79)	OPTION A	
в	7 125 1-0027	BLAC	K 3.3 VOLT SYNCHRONOU	S LEFT C	ENTER	NONE	.093 +.003/- (2.36+0.08/-	.000 0.00)	<u>.093 +.003/000</u> (2.36+0.08/-0.00)	NONE	1.739 (44.17)	<u>.155</u> (3.94)	.020 (0.51)	<u>.127</u> (3.23)	.970 (24.64)	.113 (2.87)	<u>.250</u> (6.35)	$\frac{.410}{(10.41)}$	OPTION A	в
															SHOWN (METRIC)	INCH		REV1S	E ONLY ON CAD SYSTEM	-
A												SEE	SHEET I	3 PLACE ± 2 PLACE ± 1 PLACE ± 0RAFT WHER REMAIN 1	Inch METR 0005 .01 ± 0. ± 0. UTHIN DIRENSIO	IC I)50/(1.2 168 CK 17.8mm MOLEX IN	27) PITCH T DIMM LATCH 60532 U	H MULTI-KEY RAM ASSY SALES DWG. ED ISHEET NO. 3 12 /07 /95	, A
										LTR. REVISIONS	F3	SEE SEE	SHEET I SIONS	DRWG DCB	CHK'D. D BY D. D	CB FILE N S71251	E CHAF	RT SC RING CONTAINS INFORMA AND SHOULD NOT BE USE)A-71251-0*** TION THAT IS PROPRIETARY TO DIVITHOUT WRITTEN PERMISSION	-
	13		12	П		10	9		8	7 6		5		<u>,</u>		3	· · · · · · · · · · · · · · · · · · ·	2	I	$\overline{}$